

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TIMOTHY M. LAMBERT	09/15/2014
BINAY A. KURUVILA	09/15/2014
SHAWN JOEL DUBE	09/15/2014
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14488651
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DATE SIGNED:	09/17/2014
Total Attachments: 4	
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PATENT	

ASSIGNMENT

WHEREAS, **TIMOTHY M. LAMBERT**, a citizen of the United States of America, residing at 4800 Rustown Drive, Austin, Texas 78727, **BINAY A. KURUVILA**, a citizen of the United States of America, residing at 622 Williams Way, Cedar Park, Texas 78613, and **SHAWN JOEL DUBE**, a citizen of the United States of America, residing at 3108 Yellowpine Terrace, Austin, Texas 78757, hereinafter called the "Assignors", have made the invention described in the United States patent application entitled *Systems and Methods for In-Situ Fabric Link Optimization in a Modular Information Handling System Chassis*, Attorney Docket No. 102450.00165 (103793.01), for a full description of which reference is here made to an application for Letters Patent of the United States filed on **September 17, 2014** and assigned Application Serial No. **14/488651**; and

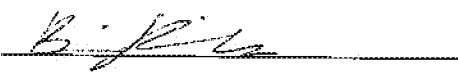
We hereby also sell, assign and transfer unto DELL PRODUCTS L.P., the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and we further authorize DELL PRODUCTS L.P. to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

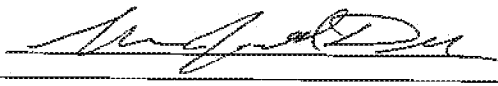
We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, continuation-in-part, or reissue, to DELL PRODUCTS L.P., for the sole use and benefit of DELL PRODUCTS L.P., its successors, assigns and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to DELL PRODUCTS L.P.

We agree that, when requested, we will, without charge to DELL PRODUCTS L.P., but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in DELL PRODUCTS L.P., its successors, assigns and legal representatives or nominees.

We covenant with DELL PRODUCTS L.P., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

NAME OF FIRST INVENTOR	TIMOTHY M. LAMBERT
SIGNATURE OF FIRST INVENTOR	<u>Timothy M. Lambert</u>
DATE	<u>9-15-14</u>

NAME OF SECOND INVENTOR	BINAY A. KURUVILA
SIGNATURE OF SECOND INVENTOR	
DATE	9/15/14

NAME OF THIRD INVENTOR	SHAWN JOEL DUBE
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